



# TSM2312

## 20V N-Channel Enhancement Mode MOSFET

SOT-23



Pin assignment:

1. Gate
2. Source
3. Drain

$V_{DS} = 20V$

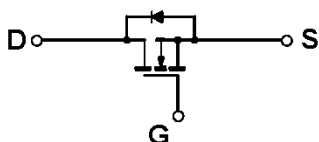
$R_{DS(on)}, V_{GS} @ 4.5V, I_{DS} @ 5.0A = 33m\Omega$

$R_{DS(on)}, V_{GS} @ 2.5V, I_{DS} @ 4.0A = 40m\Omega$

### Features

- ◇ Advanced trench process technology
- ◇ High density cell design for ultra low on-resistance
- ◇ Excellent thermal and electrical capabilities
- ◇ Compact and low profile SOT-23 package

### Block Diagram



### Ordering Information

Part No.	Packing	Package
TSM2312CX	Tape & Reel	SOT-23

### Absolute Maximum Rating ( $T_a = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	20V	V	
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V	
Continuous Drain Current	$I_D$	5	A	
Pulsed Drain Current	$I_{DM}$	15	A	
Maximum Power Dissipation		$T_a = 25^\circ C$	1.25	W
		$T_a = 75^\circ C$	0.8	
Operating Junction Temperature	$T_J$	+150	$^\circ C$	
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	- 55 to +150	$^\circ C$	

### Thermal Performance

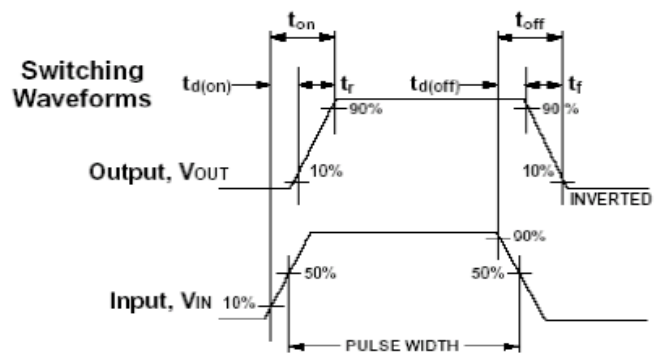
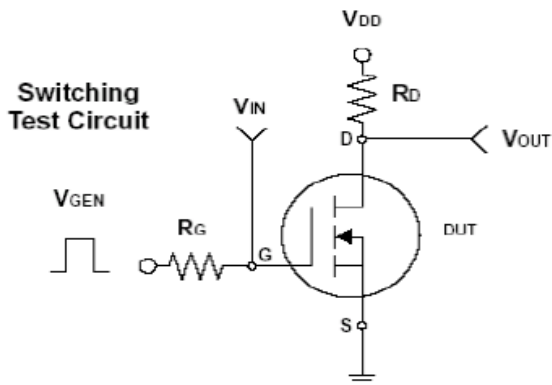
Parameter	Symbol	Limit	Unit
Lead Temperature (1/8" from case)	$T_L$	5	S
Junction to Ambient Thermal Resistance (PCB mounted)	$R_{\theta ja}$	100	$^\circ C/W$

Note: Surface mounted on FR4 board  $t \leq 5sec.$

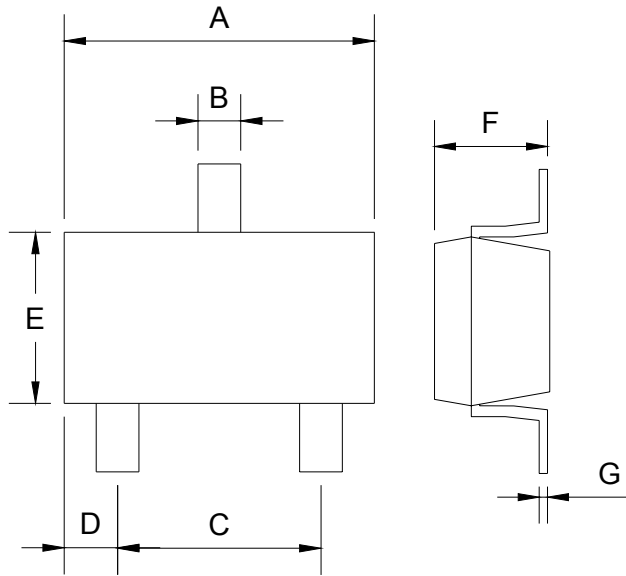


Electrical Characteristics						
Ta = 25 °C, unless otherwise noted						
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA	BV <sub>DSS</sub>	20	--	--	V
Drain-Source On-State Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5.0A	R <sub>DS(ON)</sub>	--	25	33	mΩ
Drain-Source On-State Resistance	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 4.0A	R <sub>DS(ON)</sub>	--	35	40	
Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	V <sub>GS(TH)</sub>	0.45	--	--	V
Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	I <sub>DSS</sub>	--	--	1.0	uA
Gate Body Leakage	V <sub>GS</sub> = ± 8V, V <sub>DS</sub> = 0V	I <sub>GSS</sub>	--	--	± 100	nA
On-State Drain Current	V <sub>DS</sub> ≥ 10V, V <sub>GS</sub> = 4.5V	I <sub>D(ON)</sub>	15	--	--	A
Forward Transconductance	V <sub>DS</sub> = 5V, I <sub>D</sub> = 5.0A	g <sub>fs</sub>	--	20	--	S
<b>Dynamic</b>						
Total Gate Charge	V <sub>DS</sub> = 10V, I <sub>D</sub> = 3.6A, V <sub>GS</sub> = 4.5V	Q <sub>g</sub>	--	11	14	nC
Gate-Source Charge		Q <sub>gs</sub>	--	1.4	--	
Gate-Drain Charge		Q <sub>gd</sub>	--	2.2	--	
Turn-On Delay Time	V <sub>DD</sub> = 10V, R <sub>L</sub> = 10Ω, I <sub>D</sub> = 1A, V <sub>GEN</sub> = 4.5V, R <sub>G</sub> = 6Ω	t <sub>d(on)</sub>	--	15	25	nS
Turn-On Rise Time		t <sub>r</sub>	--	40	60	
Turn-Off Delay Time		t <sub>d(off)</sub>	--	48	70	
Turn-Off Fall Time		t <sub>f</sub>	--	31	45	
Input Capacitance	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1.0MHz	C <sub>iss</sub>	--	900	--	pF
Output Capacitance		C <sub>oss</sub>	--	140	--	
Reverse Transfer Capacitance		C <sub>rss</sub>	--	100	--	
<b>Source-Drain Diode</b>						
Max. Diode Forward Current		I <sub>S</sub>	--	--	1.6	A
Diode Forward Voltage	I <sub>S</sub> = 1.0A, V <sub>GS</sub> = 0V	V <sub>SD</sub>	--	0.75	1.2	V

Note : pulse test: pulse width ≤ 300uS, duty cycle ≤ 2%



## SOT-23 Mechanical Drawing



SOT-23 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.88	2.91	0.113	0.115
B	0.39	0.42	0.015	0.017
C	1.78	2.03	0.070	0.080
D	0.51	0.61	0.020	0.024
E	1.59	1.66	0.063	0.065
F	1.04	1.08	0.041	0.043
G	0.07	0.09	0.003	0.004